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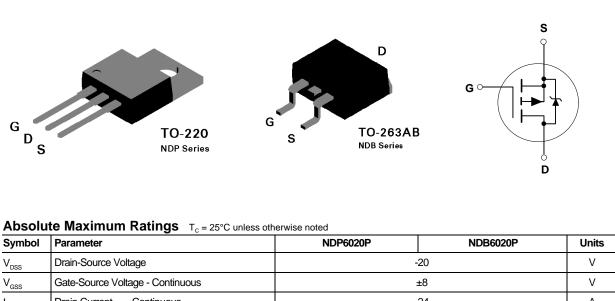
# NDP6020P / NDB6020P P-Channel Logic Level Enhancement Mode Field Effect Transistor

## **General Description**

These logic level P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as automotive, DC/DC converters, PWM motor controls, and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

### Features

- $\begin{array}{r|l} \bullet & -24 \text{ A}, -20 \text{ V}. \text{ R}_{\text{DS(ON)}} = 0.05 \ \Omega \ @ \text{ V}_{\text{GS}} = -4.5 \text{ V}. \\ \text{ R}_{\text{DS(ON)}} = 0.07\Omega \ @ \text{ V}_{\text{GS}} = -2.7 \text{ V}. \\ \text{ R}_{\text{DS(ON)}} = 0.075 \ \Omega \ @ \text{ V}_{\text{GS}} = -2.5 \text{ V}. \end{array}$
- Critical DC electrical parameters specified at elevated temperature.
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor.
- 175°C maximum junction temperature rating.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- TO-220 and TO-263 (D<sup>2</sup>PAK) package for both through hole and surface mount applications.



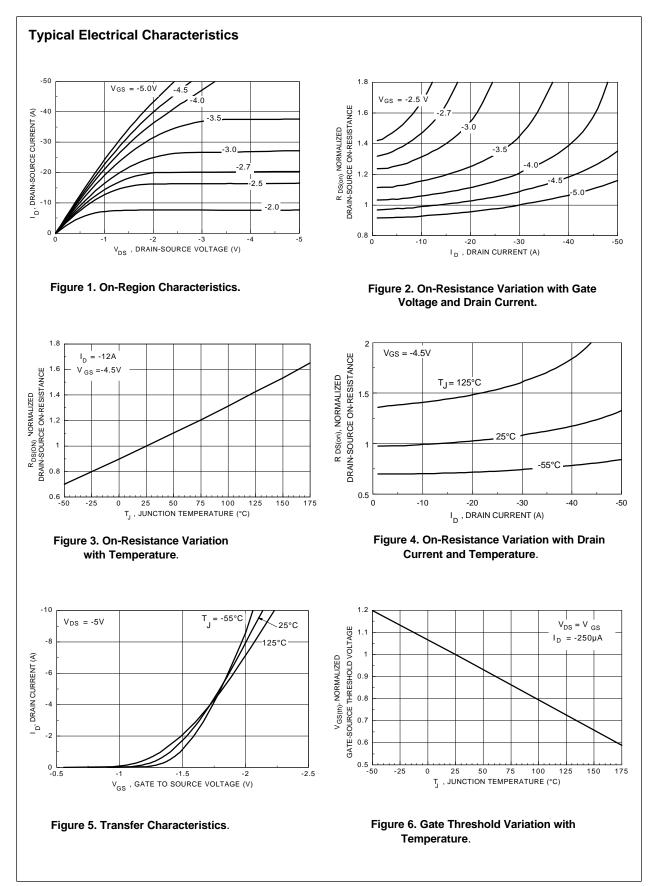
635	0			
I <sub>D</sub>	Drain Current - Continuous	-24	А	
	- Pulsed	-70		
P <sub>D</sub>	Total Power Dissipation @ $T_c = 25^{\circ}C$	60	W	
	Derate above 25°C	0.4	W/°C	
T_J,T <sub>STG</sub>	Operating and Storage Temperature Range	-65 to 175	°C	

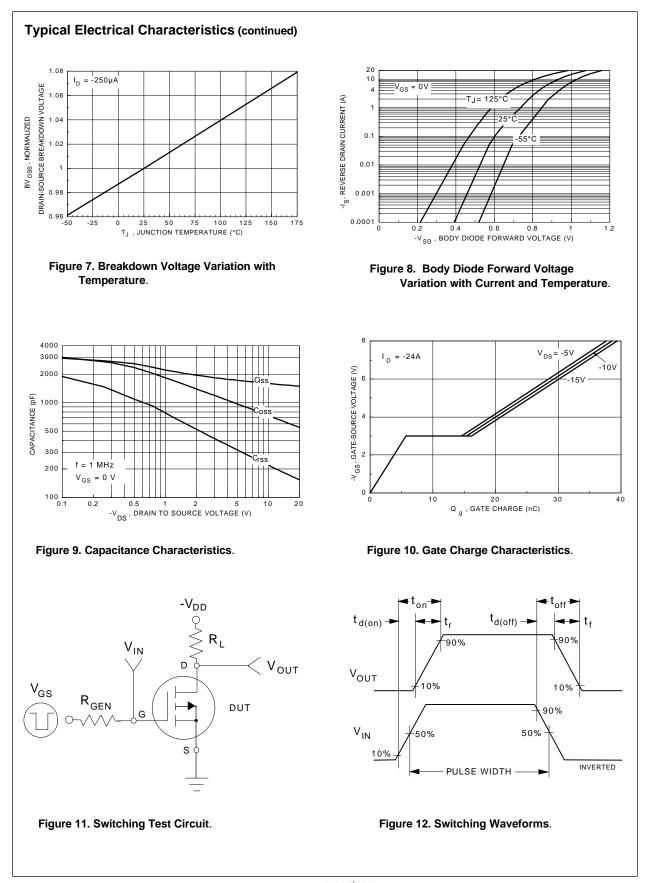
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CH/	ARACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		-20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\rm DS}$ = -16 V, $V_{\rm GS}$ = 0 V				-1	μA
			$T_J = 55^{\circ}C$			-10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAI	RACTERISTICS (Note 1)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = -250 \ \mu A$		-0.4	-0.7	-1	V
			$T_J = 125^{\circ}C$	-0.3	-0.56	-0.7	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -12 \text{ A}$	-		0.041	0.05	Ω
			$T_J = 125^{\circ}C$		0.06	0.08	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -2.7 \text{ V}, I_{D} = -10 \text{ A}$			0.059	0.07	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -2.5 \text{ V}, I_{D} = -10 \text{ A}$			0.064	0.075	
D(on)	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-24			А
g <sub>fs</sub>	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -12 A$			14		S
DYNAMI	CCHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			1590		pF
C <sub>oss</sub>	Output Capacitance				725		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				215		pF
SWITCHI	NG CHARACTERISTICS (Note 1)	·					
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = -20 \text{ V}, \text{ I}_{D} = -3 \text{ A},$ $V_{GS} = -5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			15	30	nS
ţ,	Turn - On Rise Time				27	60	nS
t <sub>D(off)</sub>	Turn - Off Delay Time				120	250	nS
t <sub>f</sub>	Turn - Off Fall Time				70	150	nS
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -10 V,$ $I_{D} = -24 A, V_{GS} = -5 V$			25	35	nC
Q <sub>gs</sub>	Gate-Source Charge				5		nC
Q <sub>gd</sub>	Gate-Drain Charge				10		nC

Electri	cal Characteristics ( $T_c = 25^{\circ}C$ unle	ess otherwise noted)				
Symbol	Parameter	Conditions	Min	Тур	Max	Units
DRAIN-S	OURCE DIODE CHARACTERISTICS					
ls	Maximum Continuous Drain-Source Diod	ntinuous Drain-Source Diode Forward Current			-24	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				-80	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -12 \text{ A} \text{ (Note 1)}$		-1.1	-1.3	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_F = -24 A,$ $-dI_F/dt = 100 A/\mu s$		60		ns
l <sub>rr</sub>	Reverse Recovery Current			-1.7		Α
THERMA	L CHARACTERISTICS		·		•	•
R <sub>øJC</sub>	Thermal Resistance, Junction-to-Case				2.5	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient				62.5	°C/W

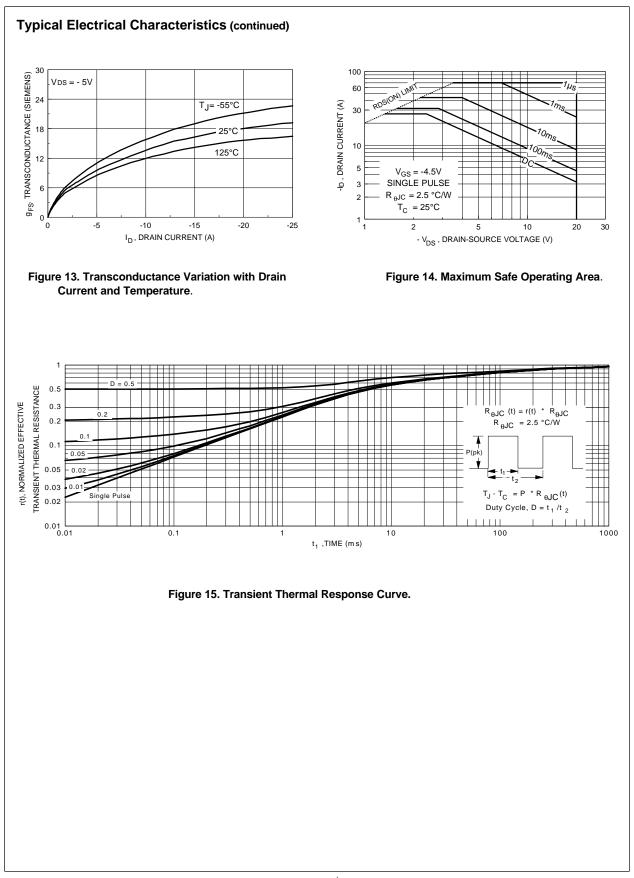
Note:

1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.





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